FMX-4206S

Fast Recovery Diode

Jan. 2010

General Description

FRD that has great balance low-VF and high speed performance is incorporated into high-current package TO-3PF.

It achieved a balance between high speed at high temperature operates and low-VF.

Applications

- DCM or CCM type PFC circuit (Power factor improvement circuit)
- DC-DC converters. (Forward type/ flyback type/ current resonance type)

Features

- An ultrafast recovery diode.
- A balance low-VF and high speed performance at high temperature.
- A great radiation performance due to high-current package.
- A great isolation performance due to full mold package.

Package (TO-3PF 3pin)



Key Specifications

| Item | Unit | Rating | Conditions | | | | | | |
|--|------|--------|---------------------|--|--|--|--|--|--|
| V _{RM} | V | 600 | | | | | | | |
| V _F | V | 1.5 | I _F =10A | | | | | | |
| I _{F(AV)} | А | 20 | | | | | | | |
| t _{rr} 1 | ns | 30 | | | | | | | |
| t _{rr} 1 t _{rr} 2 | ns | _ | | | | | | | |

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Typical Characteristics

VF-IF & VR-IR show characteristics per one chip.

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* Absolute maximum ratings

| No. | Item | Symbol | Unit | Rating | Conditions |
|----------------------------------|-----------------------------------|-----------------------------|--------|----------|---------------------------------|
| 1 Transient Peak Reverse Voltage | | V_{RSM} | V | 600 | |
| 2 Peak Reverse Voltage | | $V_{\rm RM}$ | V | 600 | |
| 3 | 3 Average Forward Current | | А | 20 | Refer to Derating (Page4) |
| 4 | 4 Peak Surge Forward Current | | А | 100 | 10msec. Half sinewave, one shot |
| 5 | 5 I ² t Limiting Value | | A^2s | 50 | 1msec≦t≦10msec |
| 6 | Junction Temperature | T_j | °C | -40~+150 | |
| 7 | Storage Temperature | $\mathrm{T}_{\mathrm{stg}}$ | °C | -40~+150 | |

No.1,2,4&5 show characteristics per one chip.

***** Electrical characteristics (Ta=25°C, unless otherwise specified)

| No. | Item | Symbol | Unit | Value | Conditions |
|------------------------|---|---|------|-----------|---|
| 1 Forward Voltage Drop | | V_{F} | V | 1.5 max. | I _F =10A |
| 2 | Reverse Leakage Current | I_{R} | uA | 100 max. | V _R =V _{RM} |
| 3 | Reverse Leakage Current Under High Temperature | $H \cdot I_R$ | mA | 20 max. | V _R =V _{RM} , T _j =150°C |
| 4 | Reverse Recovery Time | t_{rr} | ns | 30 max. | I _F =I _{RP} =500mA 90% Recovery point, T _j =25°C |
| | | $\mathrm{H} \cdot \mathrm{t}_{\mathrm{rr}}$ | ns | 102 typ . | I _F =I _{RP} =500mA 90% Recovery point, T _j =150°C |
| 5 | Forward Voltage Drop | $R_{th(j\text{-}c)}$ | °C/W | 2.0 max. | Between Junction and case |

No.1,2,3&4 show characteristics per one chip.

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* Characteristics



★ Derating



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★ Package information (mm)



* Marking



X4206S: Part number FMX-4206S is described "X4206S". XXXX: Lot number (manufacture year, month, day) is described 4-digit numbers.

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